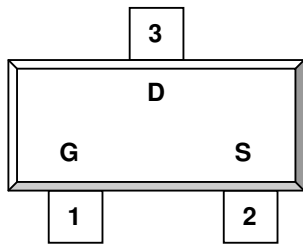


DESCRIPTION

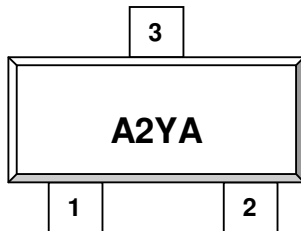
ST3402 is the N-Channel logic enhancement mode power field effect transistor which is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management, other battery powered circuits, and low in-line power loss are required. The product is in a very small outline surface mount package.

PIN CONFIGURATION
SOT-23-3L


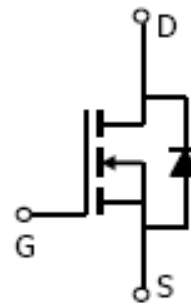
1.Gate 2.Source 3.Drain

FEATURE


- 30V/2.8A, $R_{DS(ON)} = 48m\Omega$
@ $V_{GS} = 10V$
- 30V/2.3A, $R_{DS(ON)} = 53m\Omega$
@ $V_{GS} = 4.5V$
- 30V/1.5A, $R_{DS(ON)} = 80m\Omega$
@ $V_{GS} = 2.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23-3L package design

PART MARKING
SOT-23-3L


Y: Year Code A: Week Code





ST3402 
Lead-free


N Channel Enhancement Mode MOSFET

4.0A

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	30	V
Gate-Source Voltage	V _{GSS}	±12	V
Continuous Drain Current (T _J =150°C)	I _D	4.0	A
		T _A =25°C T _A =70°C	
Pulsed Drain Current	I _{DM}	10	A
Continuous Source Current (Diode Conduction)	I _S	1.25	A
Power Dissipation	P _D	1.25	W
		T _A =25°C T _A =70°C	
Operation Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	100	°C/W



ST3402 

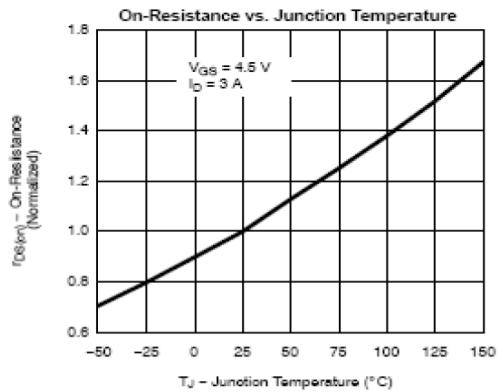
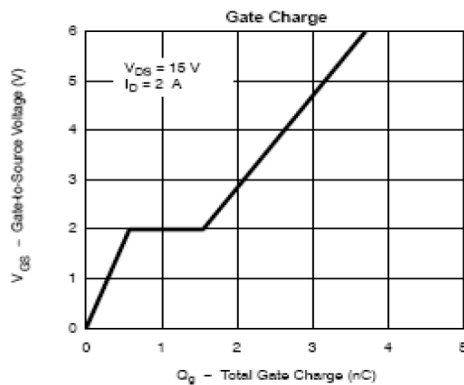
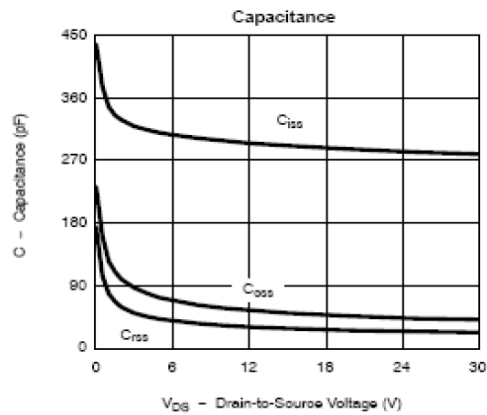
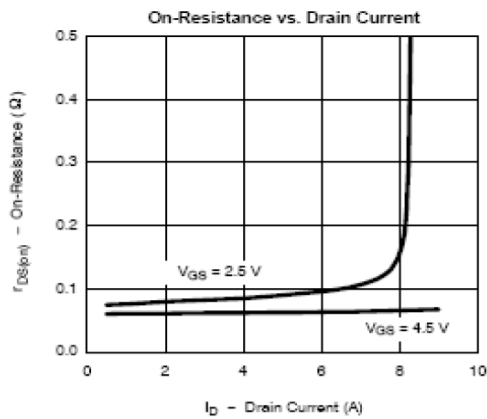
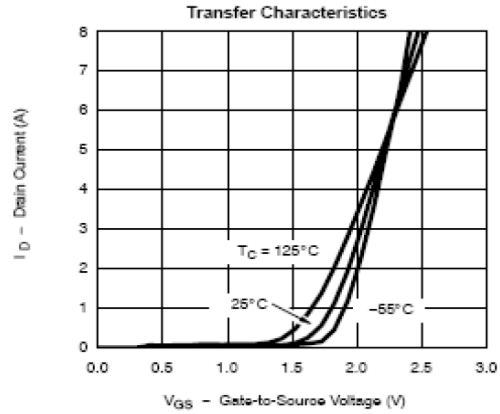
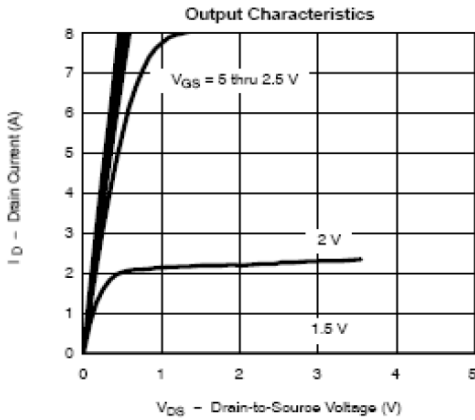
N Channel Enhancement Mode MOSFET

4.0A

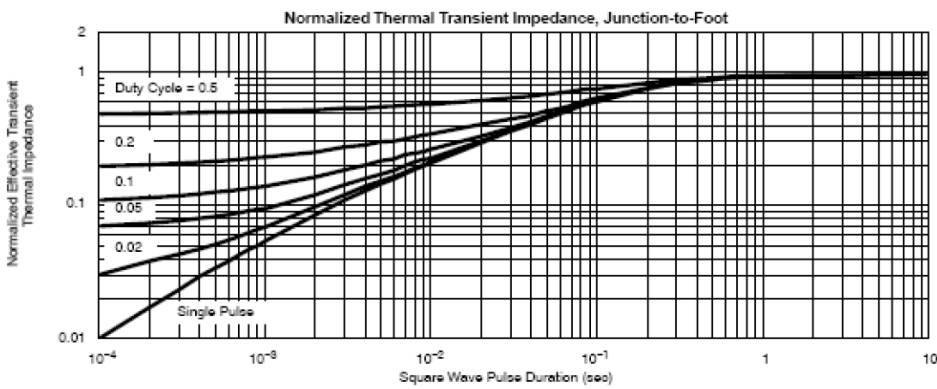
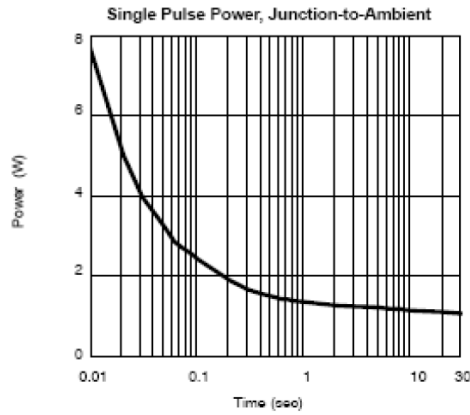
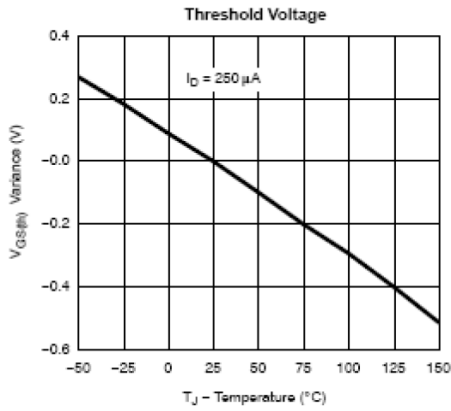
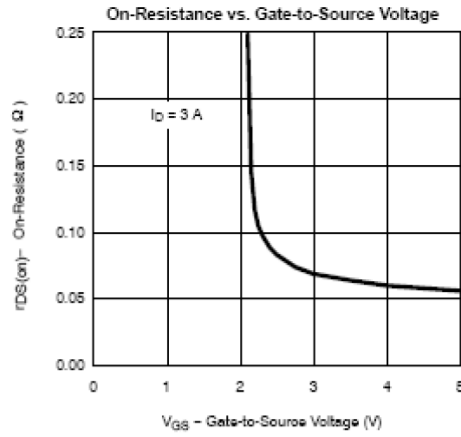
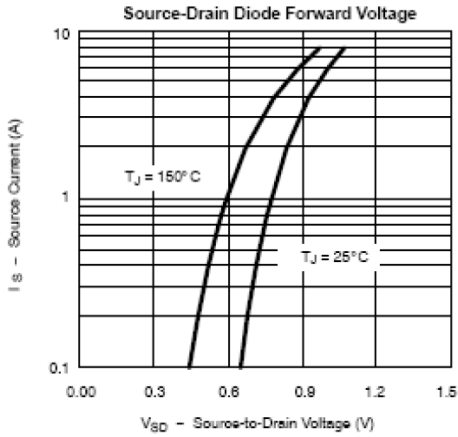
ELECTRICAL CHARACTERISTICS (Ta = 25°C unless otherwise noted)

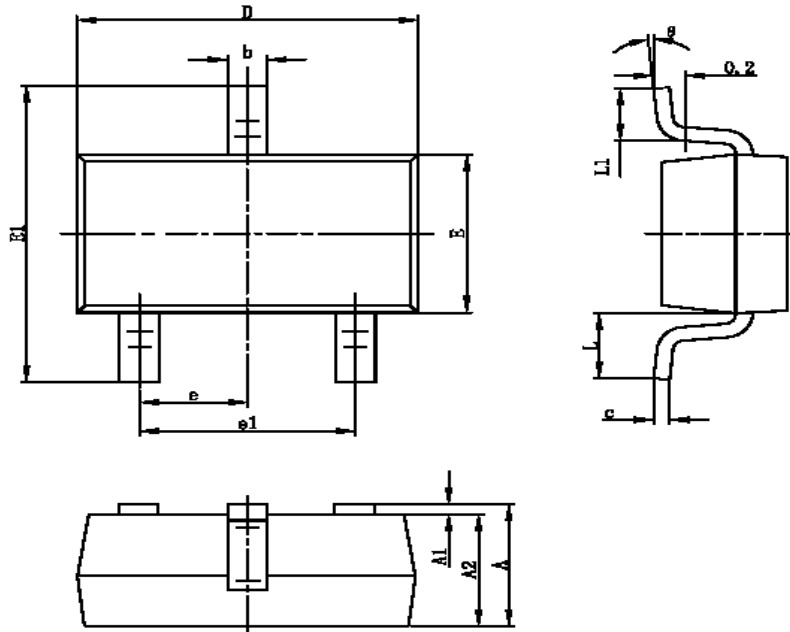
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.8		1.6	V
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=24V, V_{GS}=0V$			1	uA
		$V_{DS}=24V, V_{GS}=0V$ $T_J=55^\circ C$			10	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \geq 4.5V, V_{GS}=4.5V$	4			A
Drain-source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=2.8A$		48		mΩ
		$V_{GS}=4.5V, I_D=4.5A$		53		
		$V_{GS}=2.5V, I_D=1.5A$		80		
Forward Transconductance	g_{fs}	$V_{DS}=4.5V, I_D=5.8A$		12		S
Diode Forward Voltage	V_{SD}	$I_S=1.25A, V_{GS}=0V$		0.8	1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=15V$ $V_{GS}=4.5V$ $I_D=2.0A$		4.2	6	nC
Gate-Source Charge	Q_{gs}			0.6		
Gate-Drain Charge	Q_{gd}			1.5		
Input Capacitance	C_{iss}	$V_{DS}=15V$ $V_{GS}=0V$ $F=1MHz$		350		pF
Output Capacitance	C_{oss}			55		
Reverse Transfer Capacitance	C_{rss}			41		
Turn-On Time	$t_{d(on)}$ t_r	$V_{DD}=15V$ $R_L=10\Omega$ $I_D=1.0A$ $V_{GEN}=10V$ $R_G=3\Omega$		2.5		nS
				2.5		
Turn-Off Time	$t_{d(off)}$ t_f			20		
				4		

TYPICAL CHARACTERISTICS (25°C unless otherwise noted)



TYPICAL CHARACTERISTICS (25°C unless otherwise noted)



SOT-23-3L PACKAGE OUTLINE


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°